

## HIGH VOLTAGE DRIVER FOR CFL

- n BCD-OFF LINE TECHNOLOGY
- n FLOATING SUPPLY VOLTAGE UP TO 570V
- n GND REFERRED SUPPLY VOLTAGE UP TO 18V
- n UNDER VOLTAGE LOCK OUT
- n CLAMPING ON  $V_s$
- n DRIVER CURRENT CAPABILITY:  
30mA SOURCE  
70mA SINK
- n PREHEAT AND FREQUENCY SHIFT TIMING

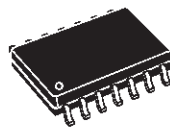
### DESCRIPTION

The device is a monolithic high voltage integrated circuit designed to drive CFL and small TL lamps with a minimum part count.

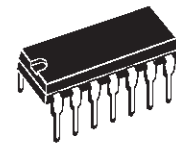
It provides all the necessary functions for proper pre-heat, ignition and steady state operation of the lamp:

- ◆ variable frequency oscillator;

### MULTIPOWER BCD TECHNOLOGY



SO14

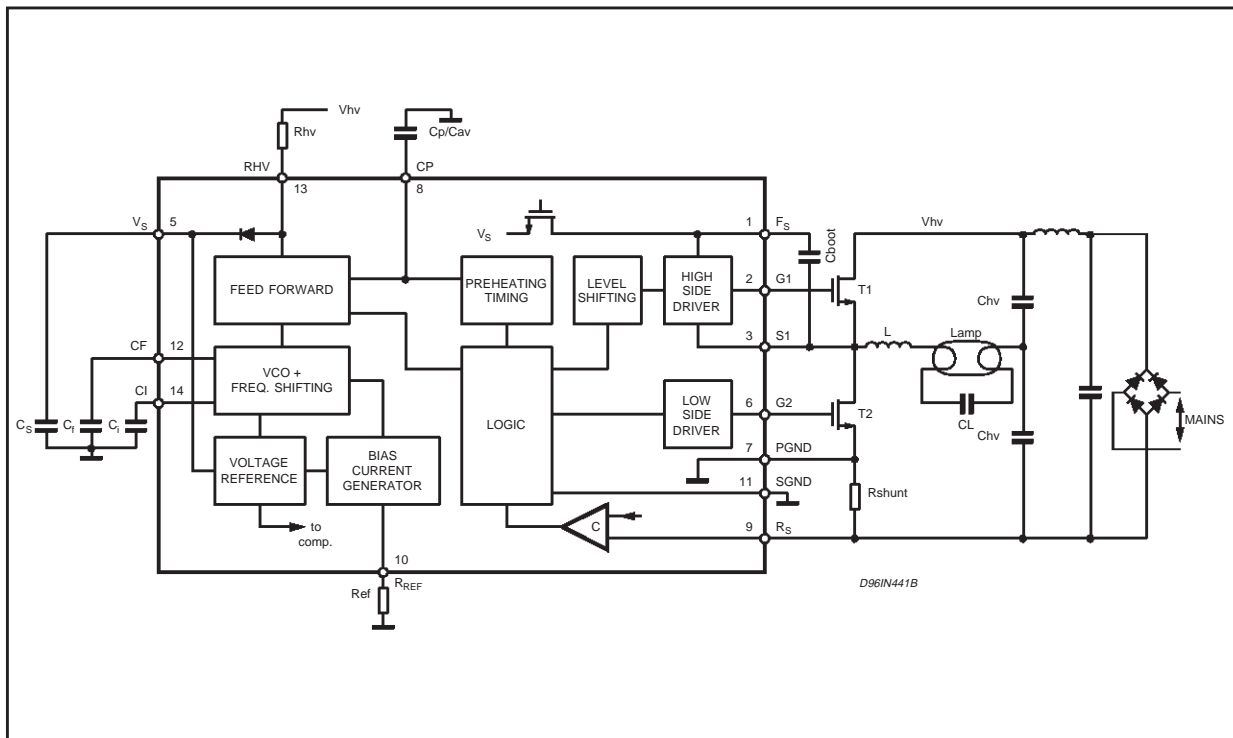


DIP14

ORDERING NUMBERS:  
L6567D                      L6567

- ◆ settable preheating and ignition time;
  - ◆ capacitive mode protection;
  - ◆ lamp power independent from mains voltage variation.
- Besides the control functions, the IC provides the level shift and drive function for two external power MOS FETs in a half-bridge topology.

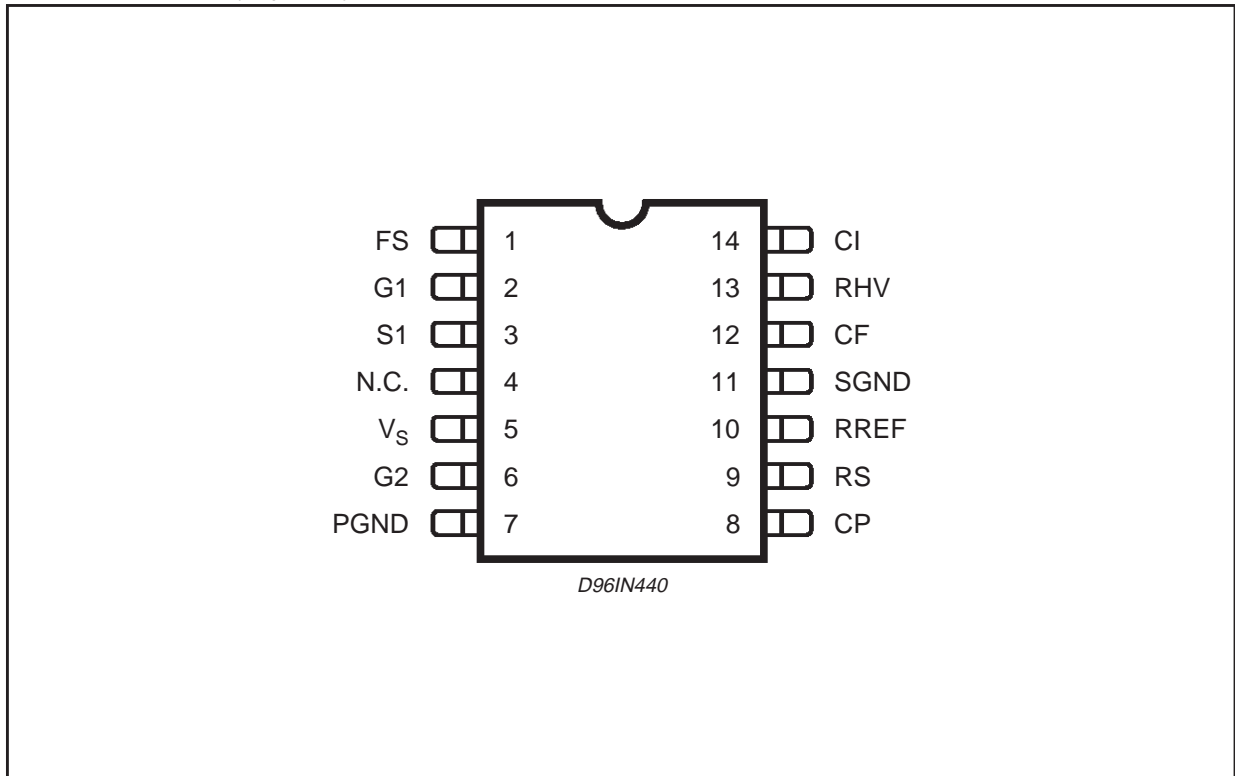
### BLOCK DIAGRAM



## PIN FUNCTION

N°	Pin	Description
1	F <sub>S</sub>	Floating Supply of high side driver
2	G1	Gate of high side switch
3	S1	Source of high side switch
4	NC	High Voltage Spacer. (Should be not connected)
5	V <sub>S</sub>	Supply Voltage for GND level control and drive
6	G2	Gate of low side switch
7	PGND	Power Ground
8	CP	First timing (TPRE TIGN), then averaging the ripple in the representation of the HVB (derived through RHV).
9	R <sub>S</sub>	R <sub>SHUNT</sub> : current monitoring input
10	R <sub>REF</sub>	Reference resistor for current setting
11	SGND	Signal Ground. Internally Connected to PGND
12	CF	Frequency setting capacitor
13	RHV	Start-up supply resistor, then supply voltage sensing.
14	CI	Timing capacitor for frequency shift

## PIN CONNECTION (Top view)



## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V <sub>S</sub>	Low Voltage Supply	18 (1)	V
V <sub>RHV</sub>	Mains Voltage Sensing	V <sub>S</sub> +2V <sub>BE</sub> (2)	
V <sub>CP</sub>	Preheat/Averaging	5	V
V <sub>CF</sub>	Oscillator Capacitor Voltage	5	V
V <sub>CI</sub>	Frequency Shift Capacitor Voltage	5	V
V <sub>RREF</sub>	Reference Resistor Voltage	5	V
V <sub>RS</sub>	Current Sense Input Voltage	-5 to 5	V
	transient 50ns	-15	V
V <sub>G2</sub>	Low Side Switch Gate Output	18	V
V <sub>S1</sub>	High Side Switch Source Output: normal operation	-1 to 373	V
	0.5sec mains transient	-1 to 550	V
V <sub>G1</sub>	High Side Switch Gate Output: normal operation	-1 to 391	V
	0.5sec mains transient	-1 to 568	V
	with respect to pin S1	V <sub>be</sub> to V <sub>S</sub>	V
V <sub>FS</sub>	Floating Supply Voltage: normal operation	391	V
	0.5sec mains transient	568	V
V <sub>FS/S1</sub>	Floating Supply vs S1 Voltage	18	V
ΔV <sub>FS</sub> /ΔT	VFS Slew Rate (Repetitive)	-4 to 4	V/ns
ΔV <sub>S1</sub> /ΔT	VS1 Slew Rate (Repetitive)	-4 to 4	V/ns
I <sub>RHV</sub>	Current Into R <sub>HV</sub>	3 (3)	mA
I <sub>Vs</sub>	Clamped Current into V <sub>S</sub>	200 (4)	mA
T <sub>stg</sub>	Storage Temperature	-40 to 150	°C
T <sub>j</sub>	Junction Temperature	-40 to 150	°C

NOTES: (1) Do not exceed package thermal dissipation limits

(2) For V<sub>S</sub> ≤ V<sub>S</sub> high 1

(3) For V<sub>S</sub> > V<sub>S</sub> high 1

(4) Internally Limited

Note: ESD immunity for pins 1, 2 and 3 is guaranteed up to 900 V (Human Body Model)

**ELECTRICAL CHARACTERISTICS**(V<sub>S</sub> = 12V; R<sub>REF</sub> = 30KΩ; C<sub>F</sub> = 100pF; T<sub>j</sub> = 25°C; unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
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**V<sub>S</sub> - SUPPLY VOLTAGE SECTION**

V <sub>S high 1</sub>	V <sub>S</sub> Turn On Threshold		10.7	11.7	12.7	V
V <sub>S high2</sub>	V <sub>S</sub> Clamping Voltage	V <sub>S</sub> = 20mA	12	13	14	V
V <sub>S low 2</sub>	V <sub>S</sub> Turn Off Threshold		9	10	11	V
V <sub>S HYST</sub>	Supply Voltage Hysteresis		1.5	1.65	1.8	V
V <sub>S low 1</sub>	V <sub>S</sub> Voltage to Guarantee V <sub>G1</sub> = "0" and V <sub>G2</sub> = "1"		1		6	V
I <sub>SSP</sub>	V <sub>S</sub> Supply Current at Start Up	V <sub>S</sub> = 10.6V Before turn on	50		250	mA
I <sub>SOP</sub>	V <sub>S</sub> Supply Operative Current	V <sub>S</sub> = V <sub>S high 1</sub>			1.2	mA

**OSCILLATOR SECTION**

f <sub>osc min</sub>	Minimum Oscillator frequency	I <sub>RHV</sub> = 0mA; C <sub>I</sub> = 5V	41.7	43	44.29	KHz
f <sub>osc 600m</sub>	Feed Forward Frequency	I <sub>RHV</sub> = 600mA	47.88	50.4	52.92	KHz
f <sub>osc 1mA</sub>	Feed Forward Frequency	I <sub>RHV</sub> = 1mA	79.8	84	88.2	KHz
f <sub>osc max</sub>	Maximum Oscillator Frequency	C <sub>I</sub> = 0V	96.75	107.5	118.25	KHz
ΔI <sub>CF</sub> /ΔV <sub>CI</sub>	Oscillator Transconductance		9		17.5	μA/V

**PREHEAT/IGNITION SECTION**

P.H.T.	Preheat Time	C <sub>p</sub> = 150nF	0.88	1	1.12	sec
P.H.clocks	Number of Preheat Clocks			16		
IGN.clocks	Number of Ignition Clocks			15		

**RATE OF FREQUENCY CHANGE SECTION**

I <sub>CIP charge</sub>	CI Charging Current During Preheat		106	118	130	mA
I <sub>CI charge</sub>	CI Charging Current During Ignition		1	1.2	1.4	mA
I <sub>CI disch</sub>	CI Discharge Current		-52	-47	-42	mA
V <sub>TH CI</sub>	CI Low Voltage Threshold		10		100	mV

**RS - THRESHOLD SECTION**

V <sub>CMTH</sub>	Capacitive Mode Voltage Threshold		0	20	40	mV
V <sub>PH</sub>	Preheat Voltage Threshold		-0.64	-0.6	-0.56	V

**G1 - G2 DELAY TIMES SECTION**

G1 <sub>DON</sub>	On Delay of G1 Output		1.05	1.4	1.75	μs
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**ELECTRICAL CHARACTERISTICS** (Continued)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
G2 <sub>DON</sub>	On Delay of G2 Output		1.05	1.4	1.75	μs
$\frac{G1_{DON} + G1_{ON}}{G2_{DON} + G2_{ON}}$	Ratio between Delay Time + Conduction Time of G1 and G2	I <sub>RHV</sub> = 1mA; CI = 5V CI = 0V	0.87 0.77		1.15 1.30	

**LOW SIDE DRIVER SECTION**

R <sub>on</sub> G2 so	G2 Source Output Resistance	V <sub>S</sub> = 12V, V = 3V	80		190	Ω
R <sub>on</sub> G2 si	G2 Sink Output Resistance	V <sub>S</sub> = 12V, V = 3V	65		125	Ω
R <sub>on</sub> G1 so	G1 Source Output Resistance	V <sub>S</sub> = 10V, V = 3V	80		190	Ω
R <sub>on</sub> G1 si	G1 Sink Output Resistance	V <sub>S</sub> = 10V, V = 3V	65		125	Ω

**HIGH SIDE DRIVER SECTION**

I <sub>FSLK</sub>	Leakage Current of FS PIN to GND	V <sub>FS</sub> = 568V; G1 = L V <sub>FS</sub> = 568V; G1 = H			5 5	μA μA
I <sub>S1 LK</sub>	Leakage Current of S1 PIN to GND	V <sub>S1</sub> = 568V; G1 = L V <sub>S1</sub> = 568V; G1 = H			5 5	μA μA

**BOOTSTRAP SECTION**

Boot Th	BOOTSTRAP Threshold	V <sub>S</sub> = 10.6V before turn on	5 (*)			V
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**AVERAGE RESISTOR**

R <sub>AVERAGE</sub>	Average Resistor		27	38.5	50	kΩ
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(\*) Before starting the first commutation; when switching 6V is guaranteed.

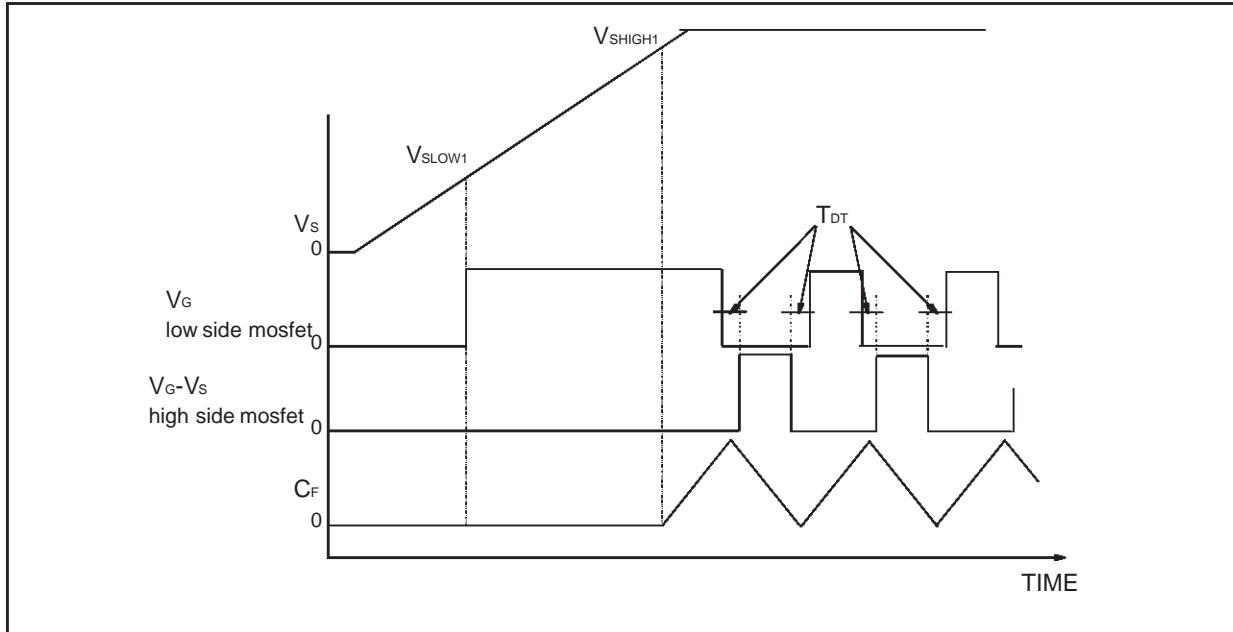
**General operation**

The L6567 uses a small amount of current from a supply resistor(s) to start the operation of the IC. Once start up condition is achieved, the IC turns on the lower MOS transistor of the half bridge which allows the bootstrap capacitor to charge. Once this is achieved, the oscillator begins to turn on the upper and lower MOS transistors at high frequency, and immediately ramps down to a preheat frequency. During this stage, the IC preheats the lamp and after a predetermined time ramps down again until it reaches the final operating frequency. The IC monitors the current to determine if the circuit is operating in capacitive mode. If capacitive switching is detected, the IC increases the output frequency until zero-voltage switching is resumed.

**Startup and supply in normal operation**

At start up the L6567 is powered via a resistor connected to the R<sub>HV</sub> pin (pin 13) from the rectified mains. The current charges the C<sub>S</sub> capacitor connected to the V<sub>S</sub> pin (pin 5). When the V<sub>S</sub> voltage reaches the threshold V<sub>S LOW1</sub> (max 6V), the low side MOS transistor is turned on while the high side one is kept off. This condition assures that the bootstrap capacitor is charged. When V<sub>S HIGH1</sub> threshold is reached the oscillator starts, and the R<sub>HV</sub> pin does not provide anymore the supply current for the IC (see fig.1).

Figure 1. Start up



### Oscillator

The circuit starts oscillating when the voltage supply  $V_S$  has reached the  $V_{S\ HIGH1}$  threshold. In steady state condition the oscillator capacitor  $C_F$  (at pin 12) is charged and discharged symmetrically with a current set mainly by the external resistor  $R_{REF}$  connected to pin 10. The value of the frequency is determined by capacitor  $C_F$  and resistor  $R_{REF}$ . This fixed value is called  $F_{MIN}$ . A dead time  $T_{DT}$  between the ON phases of the transistors is provided for avoiding cross conduction, so the duty cycle for each is less than 50%. The dead time depends on  $R_{REF}$  value (fig. 7).

The IC oscillating frequency is between  $F_{MIN}$  and  $F_{MAX} = 2.5 \cdot F_{MIN}$  in all conditions.

### Preheating mode

The oscillator starts switching at the maximum frequency  $F_{MAX}$ . Then the frequency decreases at once to reach the programmed preheating frequency (fig.2). The rate of decreasing ( $df/dt$ ) is determined by the external capacitor  $C_1$  (pin 14). The preheat time  $T_{PRE}$  is adjustable with external components ( $R_{REF}$  and  $C_p$ ). The preheat current is adjusted by sense resistance  $R_{SHUNT}$ . During the preheating time the load current is sensed with the sense resistor  $R_{SHUNT}$  (connected between pin 9- $R_S$ - and pin 7-PGND-). At pin 9 the voltage drop on  $R_{SHUNT}$  is sensed at the moment the low side MOS FET is turned off. There is an internal comparator with a fixed threshold  $V_{PH}$ : if  $V_{RS} > V_{PH}$  the frequency is decreased and if  $V_{RS} < V_{PH}$  the frequency is increased. If the  $V_{PH}$  threshold is reached, the frequency is held constant for the programmed preheating time  $T_{PRE}$ .

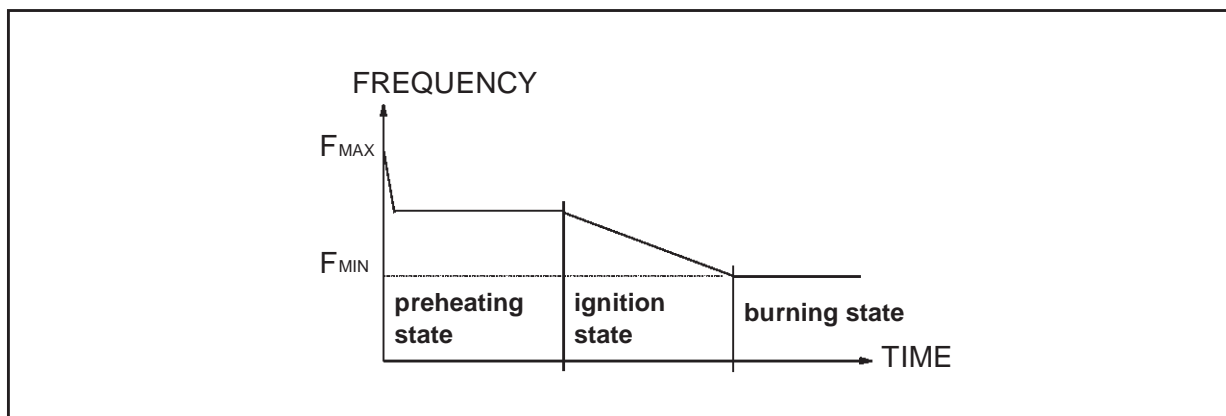
$T_{PRE}$  is determined by the external capacitor  $C_p$  (pin8) and by the resistor  $R_{REF}$ .  $C_p$  is charged 16 times with a current that depends on  $R_{REF}$ , and these 16 cycles determine the  $T_{PRE}$ .

So the preheat mode is programmable with external components as far as  $T_{PRE}$  is concerned ( $R_{REF}$  &  $C_p$ ) and as far as the preheating current is concerned (choosing properly  $R_{SHUNT}$  and the resonant load components: L and  $C_L$ ).

The circuit is held in the preheating mode when pin 8 ( $C_p$ ) is grounded.

In case  $F_{MIN}$  is reached during preheat, the IC assumes an open load. Consequently the oscillation stops with the low side MOS transistor gate on and the high side gate off. This condition is kept until  $V_S$  undershoots  $V_{SLOW1}$ .

Figure 2. Preheating and ignition state.



### Ignition mode

At the end of the preheat phase the frequency decreases to the minimum frequency ( $F_{MIN}$ ), causing an increased coil current and a high voltage appearing across the lamp. That is because the circuit works near resonance. This high voltage normally ignites the lamp. There is no protection to avoid high ignition currents through the MOS transistors when the lamp doesn't ignite. This only occurs in an end of lamp life situation in which the circuit may break. Now the lowest frequency is the resonance frequency of L and  $C_L$  (the capacitor across the lamp). The ignition phase finishes when the frequency reaches  $F_{MIN}$  or (at maximum) when the ignition time has elapsed. The ignition time is related to  $T_{PRE}$ :  $T_{IGN} = (15/16) \cdot T_{PRE}$ . The  $C_P$  capacitor is charged 15 times with the same current used to charge it during  $T_{PRE}$ .

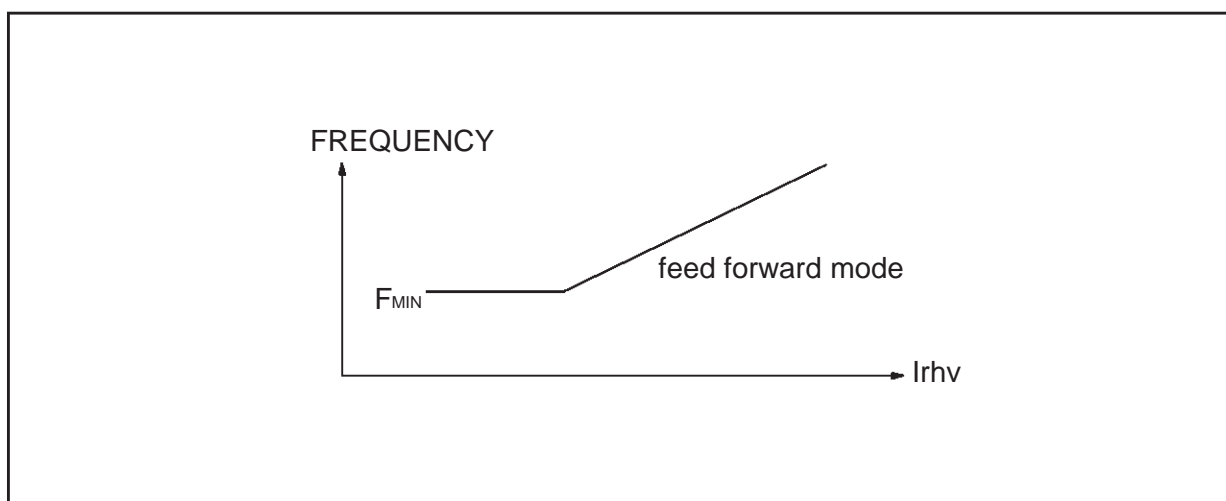
The frequency shifting slope is determined by  $C_I$ .

During the ignition time the  $V_{RS}$  monitoring function changes in the capacitive mode protection.

### Steady state operation: feed forward frequency

The lamp starts operating at  $F_{MIN}$ , determined by  $R_{REF}$  and  $C_F$  directly after the ignition phase. To prevent too high lamp power at high mains voltages, a feed forward correction is implemented. At the end of the preheat phase the  $R_{HV}$  pin is connected to an internal resistor to sense the High Voltage Bus. If the current in this resistor increases and overcomes a value set by  $R_{REF}$ , the current that charges the oscillator capacitor  $C_F$  increases too. The effect is an increase in frequency limiting the power in the lamp. In order to prevent feed forward of the ripple of the  $V_{HV}$  voltage, the ripple is filtered with capacitor  $C_P$  on pin 8 and an integrated resistor  $R_{AVERAGE}$ .

Figure 3. Burn state



**Capacitive mode protection**

During ignition and steady state the operating frequency is higher than the resonance frequency of the load (L, C<sub>L</sub>, R<sub>LAMP</sub> and R<sub>FILAMENT</sub>), so the transistors are turned on during the conduction time of the body diode in order to maintain Zero Voltage Switching.

If the operating frequency undershoots the resonance frequency ZVS doesn't occur and causes hard switching of the MOS transistors. The L6567 detects this situation by measuring V<sub>RS</sub> when the low side MOS FET is turned on. At pin 9 there is an internal comparator with threshold V<sub>CM TH</sub> (typ~20mV): if V<sub>RS</sub> < V<sub>CM TH</sub> capacitive mode is assumed and the frequency is increased as long as this situation is present. The shift is determined by CI.

**Steady state frequency**

At any time during steady state the frequency is determined by the maximum on the following three frequencies:

$$f_{\text{STEADY STATE}} = \text{MAX} \{ F_{\text{MIN}}, f_{\text{FEED FORWARD}}, f_{\text{CAPACITIVE MODE PROTECTION}} \}$$

**IC supply**

At start up the IC is supplied with a current that flows through R<sub>HV</sub> and an internal diode to the V<sub>S</sub> pin which-charges the external capacitor C<sub>S</sub>. In steady state condition R<sub>HV</sub> is used as a mains voltage sensor, so it doesn't provide anymore the supply current. The easiest way to charge the C<sub>S</sub> capacitor (and to supply the IC) is to use a charge pump from the middle point of the half bridge.

To guarantee a minimum gate power MOS drive, the IC stops oscillating when V<sub>S</sub> is lower than V<sub>S HIGH2</sub>. It will restart once the V<sub>S</sub> will become higher than V<sub>S HIGH1</sub>. A minimum voltage hysteresis is guaranteed. The IC re-starts operating at f = F<sub>MAX</sub>, then the frequency shifts towards F<sub>MIN</sub>. The timing of this frequency shifting is T<sub>IGN</sub> (that is: C<sub>P</sub> capacitor is charged and discharged 15 times). Now the oscillator frequency is controlled as in standard burning condition (feed forward and capacitive mode control). Excess charge on C<sub>S</sub> is drained by an internal clamp that turns on at voltage V<sub>S CL</sub>.

**Ground pins**

Pin 7(PGND) is the ground reference of the IC with respect to the application. Pin 11( SGND) provides a local signal ground reference for the components connected to the pins C<sub>P</sub>, C<sub>I</sub>, R<sub>REF</sub> and C<sub>F</sub>.

**Relationship between external components and sistem working condition**

L6567 is designed to drive CFL and TL lamps with a minimum part count topology. This feature implies that each external component is related to one or more circuit operating state.

This table is a short summary of these relationships:

- F<sub>MIN</sub> ---> R<sub>REF</sub> & C<sub>F</sub>
- F<sub>FEED FORWARD</sub> ---> C<sub>F</sub> & I<sub>RHV</sub>
- T<sub>PRE</sub> & T<sub>IGN</sub> ---> C<sub>P</sub> & R<sub>REF</sub>
- F<sub>PRE</sub> ---> R<sub>SHUNT</sub>, L, C<sub>L</sub>, LAMP
- T<sub>DT</sub> ---> R<sub>REF</sub>
- df/dt ---> C<sub>I</sub>

Some useful formulas can well approximate the values:

$$F_{\text{MIN}} \cong \frac{1}{8 \cdot R_{\text{REF}} \cdot C_{\text{F}}}$$

If I<sub>RHV</sub> is greater than:  $I_{\text{RHV}} \geq \frac{15}{R_{\text{REF}}}$ , the feed forward frequency is settled and the frequency value is fitted by the following expression:

$$F_{\text{FEEDFORWARD}} \cong \frac{I_{\text{RHV}}}{121 \cdot C_{\text{F}}}$$



Other easy formulas fit rather well:

$$T_{DT} \cong 46.75 \cdot 10^{-12} \cdot R_{REF}$$

$$T_{PRE} \cong 224 \cdot C_P \cdot R_{REF}$$

As far as  $df/dt$  is concerned, there are no easy formulas that fit the relation between  $C_F$ ,  $R_F$ , and  $C_I$ .  $C_I$  is charged and discharged by three different currents that are derived from different mirroring ratios by the current flowing on  $R_{REF}$ . The voltage variations on  $C_I$  are proportional to the current that charges  $C_F$ , that is to say they are proportional to  $df/dt$ .

The values obtained in the testing conditions ( $C_I = 100nF$ ) are:

during preheating and working conditions the typical frequency increase is  $\sim 20KHz/ms$ , the typical decrease is  $\sim -10KHz/ms$ ;

During ignition the frequency variation is  $\sim -200Hz/ms$ .

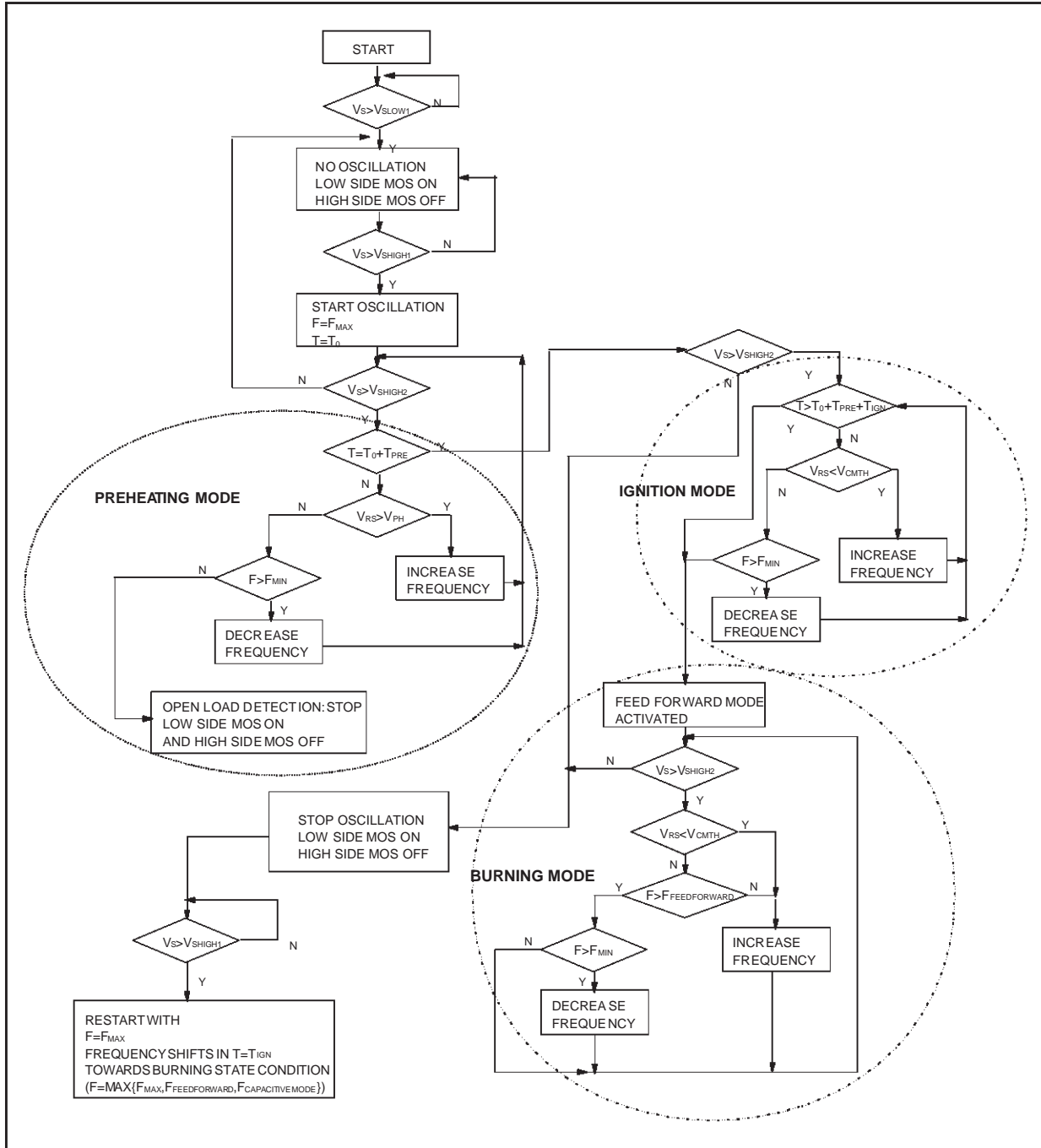
If slower variations are needed,  $C_I$  has to be increased.

Due to these tight relationships, it is recommended to follow a precise procedure: first  $R_{HV}$  has to be chosen looking at startup current needs and dissipation problems. Then the feed forward frequency range has to be determined, and so  $C_F$  is set.

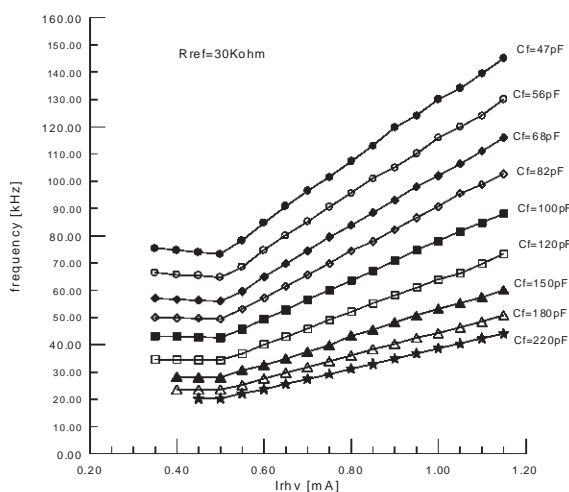
Given a certain  $C_F$ ,  $R_{REF}$  is set in order to fix  $F_{MIN}$ . Now  $C_P$  can be chosen to set the desired  $T_{PRE}$  and  $T_{IGN}$ .

The other external parameters ( $R_{SHUNT}$  and  $C_I$ ) can be chosen at the end because they are just related to a single circuit parameters.

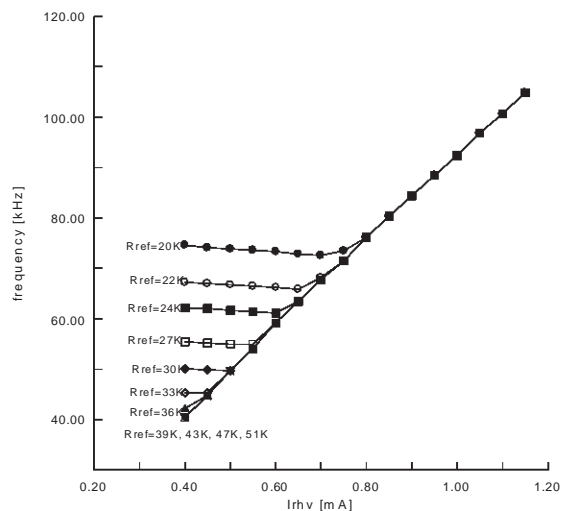
Figure 4. IC Operation



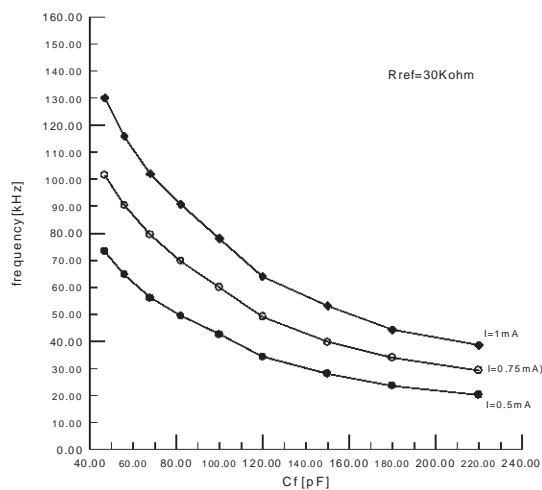
**Figure 5. Working frequency vs  $k_{HV}$  @  $R_{REF} = 30Kohm$**



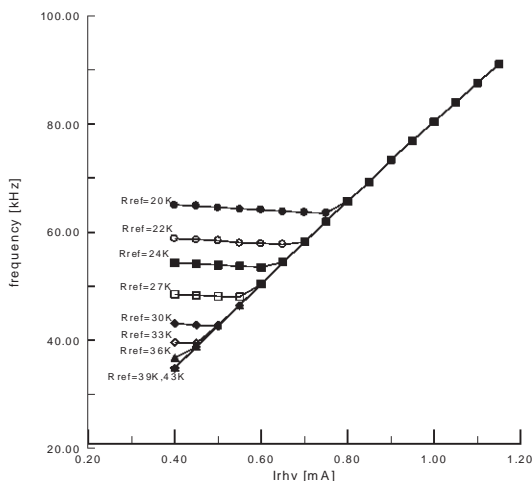
**Figure 8. Frequency vs  $k_{HV}$  @  $C_f = 82pF$**



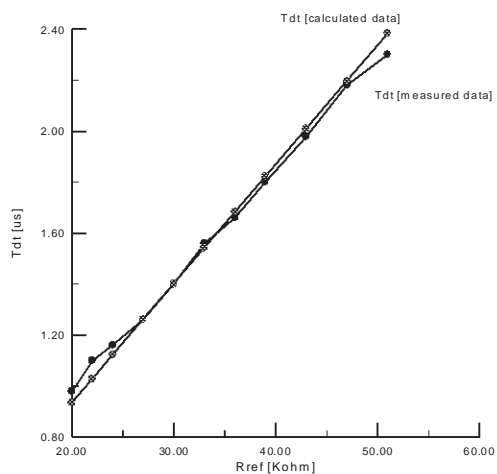
**Figure 6. Frequency vs  $C_f$  @  $R_{REF}=30Kohm$**



**Figure 9. Frequency vs  $k_{HV}$  @  $C_f=100pF$**



**Figure 7. Tdt vs  $R_{REF}$  @  $C_f = 100pF$**



**Figure 10. Frequency vs  $k_{HV}$  @  $C_f=120pF$**

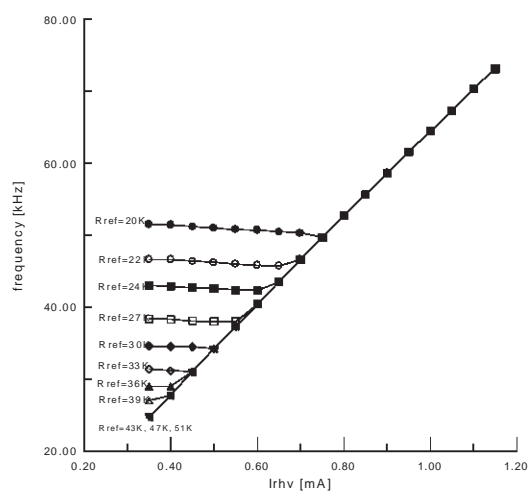


Figure 11. Frequency vs  $I_{RHV}$  @  $C_f = 150pF$

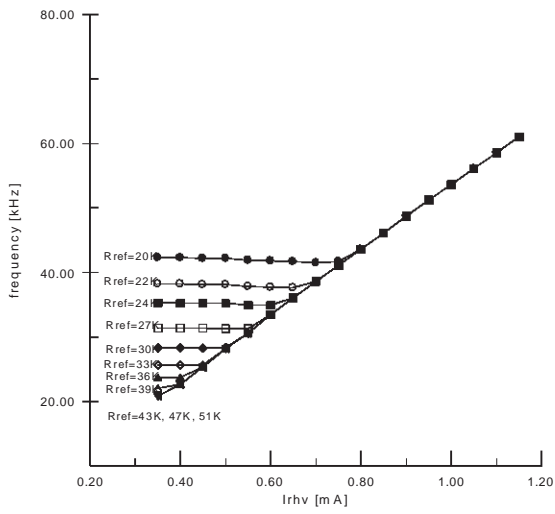


Figure 13.  $F_{FEED FORWARD}$ : measurements and calculations

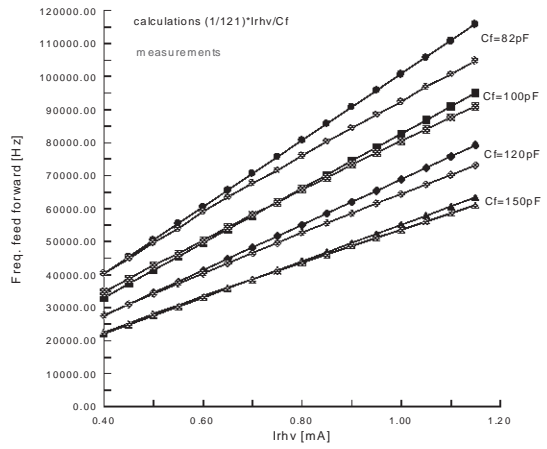
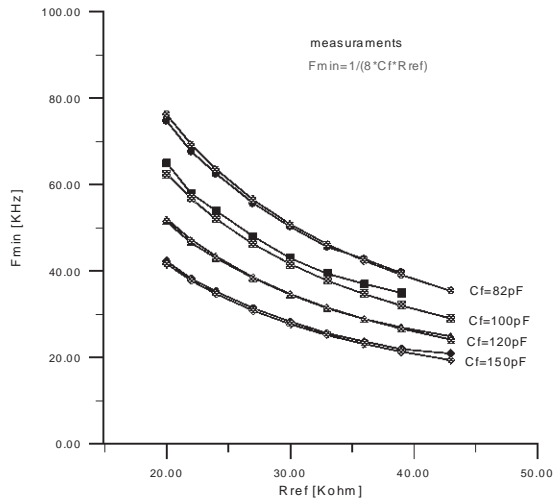
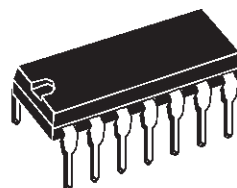


Figure 12.  $F_{MIN}$ : measurements and calculations

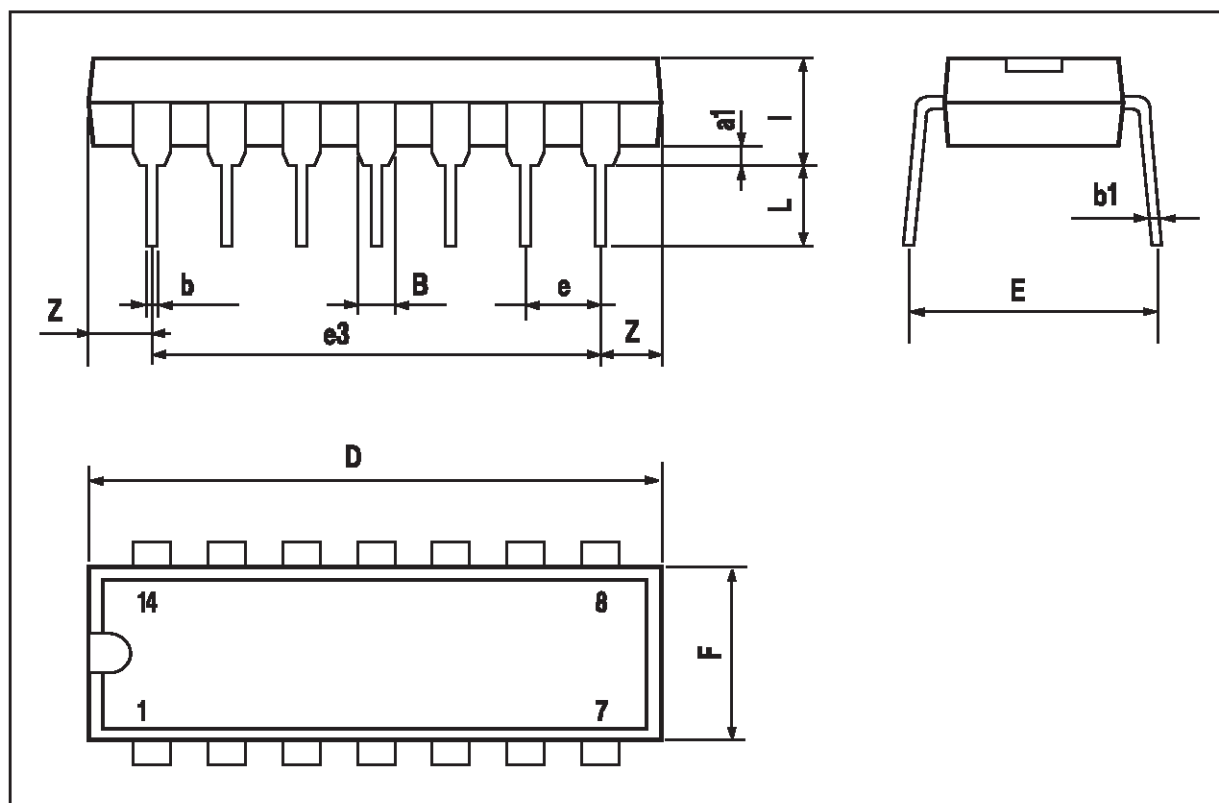


DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.51			0.020		
B	1.39		1.65	0.055		0.065
b		0.5			0.020	
b1		0.25			0.010	
D			20			0.787
E		8.5			0.335	
e		2.54			0.100	
e3		15.24			0.600	
F			7.1			0.280
I			5.1			0.201
L		3.3			0.130	
Z	1.27		2.54	0.050		0.100

## OUTLINE AND MECHANICAL DATA

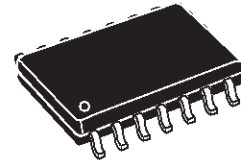


### DIP14



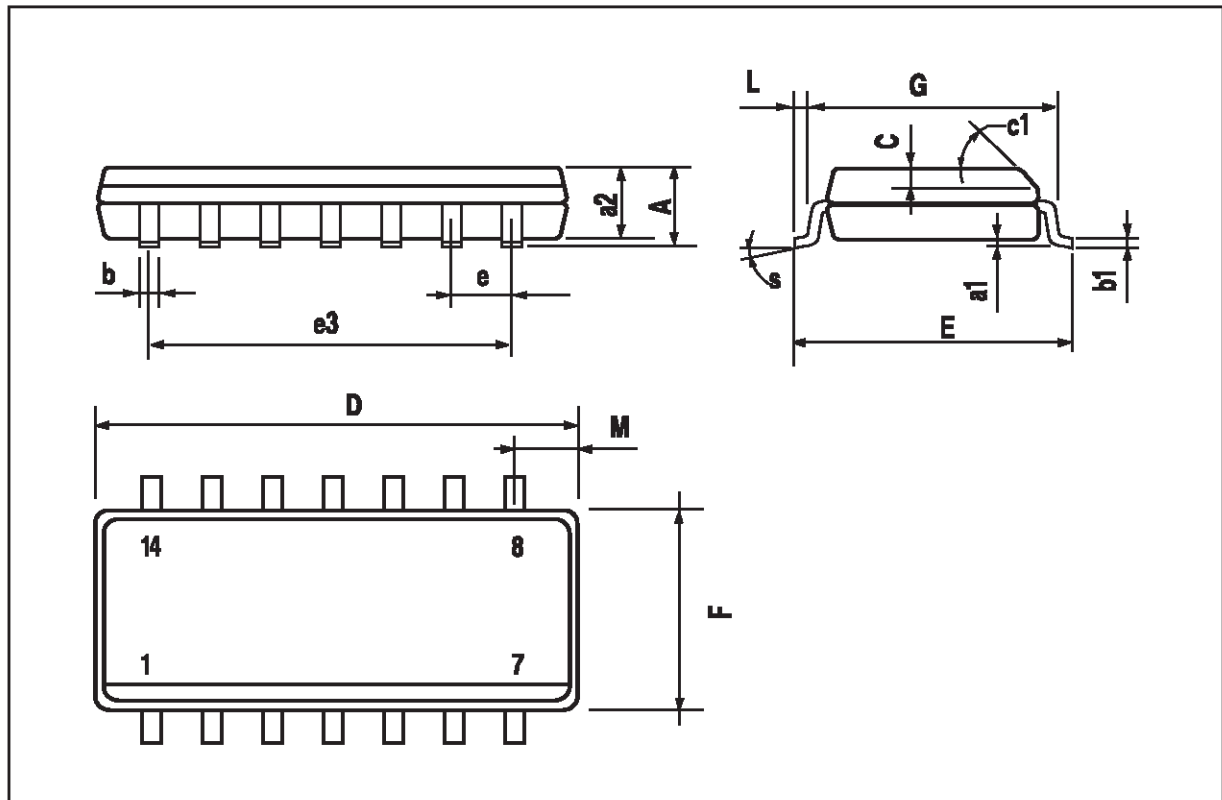
DIM.	mm			inch		
	MIN..	TYP.	MAX..	MIN..	TYP..	MAX..
A			1.75			0.069
a1	0.1		0.25	0.004		0.009
a2			1.6			0.063
b	0.35		0.46	0.014		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.020	
c1	45° (typ.)					
D (1)	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F (1)	3.8		4	0.150		0.157
G	4.6		5.3	0.181		0.209
L	0.4		1.27	0.016		0.050
M			0.68			0.027
S	8° (max)					

## OUTLINE AND MECHANICAL DATA



## SO14

(1) D and F do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm (.006inch).



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